

5A, 20V - 200V Schottky Barrier Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Low power loss, high efficiency
- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Low voltage, high frequency
- DC/DC converter
- Freewheeling diodes
- Reverse battery protection
- Car lighting

MECHANICAL DATA

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	5	A
V_{RRM}	20 - 200	V
I_{FSM}	120	A
$T_{J\ MAX}$	150	°C
Package	DO-214AB (SMC)	
Configuration	Single die	



DO-214AB (SMC)



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)											
PARAMETER	SYMBOL	SK	SK	SK	SK	SK	SK	SK	SK	SK	UNIT
		52C	53C	54C	55C	56C	59C	510C	515C	520C	
Marking code on the device		SK 52C	SK 53C	SK 54C	SK 55C	SK 56C	SK 59C	SK 510C	SK 515C	SK 520C	
Repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	90	100	150	200	V
Reverse voltage, total rms value	$V_{R(RMS)}$	14	21	28	35	42	63	70	105	140	V
Forward current	I_F	5									A
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I_{FSM}	120									A
Critical rate of rise of off-state voltage	dV/dt	10,000									V/ μs
Junction temperature	T_J	- 55 to +150									°C
Storage temperature	T_{STG}	- 55 to +150									°C

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	17	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	50	°C/W

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	SK52CH SK53CH SK54CH	$I_F = 5\text{A}, T_J = 25^\circ\text{C}$	V_F	-	0.55	V
	SK55CH SK56CH			-	0.75	V
	SK59CH SK510CH			-	0.85	V
	SK515CH SK520CH			-	0.95	V
Reverse current @ rated V_R ⁽²⁾	SK52CH SK53CH SK54CH SK55CH SK56CH	$T_J = 25^\circ\text{C}$	I_R	-	0.5	mA
	SK59CH SK510CH SK515CH SK520CH			-	0.3	mA
	SK52CH SK53CH SK54CH	$T_J = 100^\circ\text{C}$	I_R	-	20	mA
	SK55CH SK56CH			-	10	mA
	SK59CH SK510CH SK515CH SK520CH			-	-	mA
	SK52CH SK53CH SK54CH	$T_J = 125^\circ\text{C}$	I_R	-	-	mA
	SK55CH SK56CH			-	-	mA
	SK59CH SK510CH SK515CH SK520CH			-	5	mA

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION		
ORDERING CODE⁽¹⁾	PACKAGE	PACKING
SK5xCH	DO-214AB (SMC)	3,000 / Tape & Reel

Notes:

1. "x" defines voltage from 20V(SK52CH) to 200V(SK520CH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

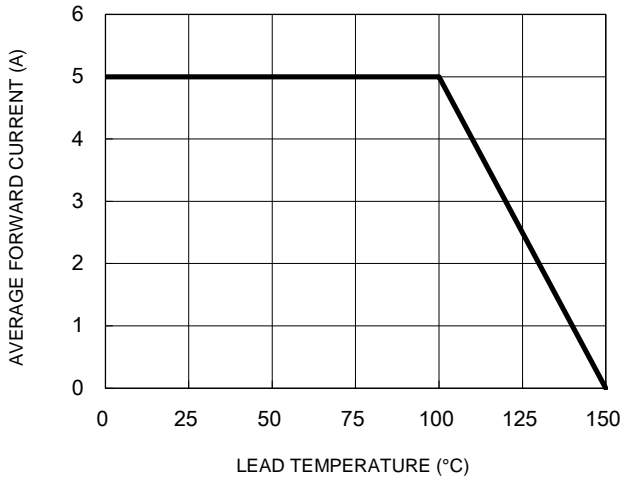


Fig.2 Typical Junction Capacitance

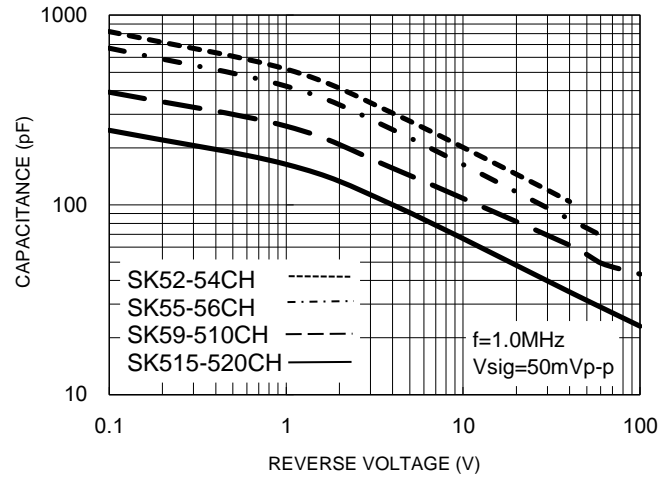


Fig.3 Typical Reverse Characteristics

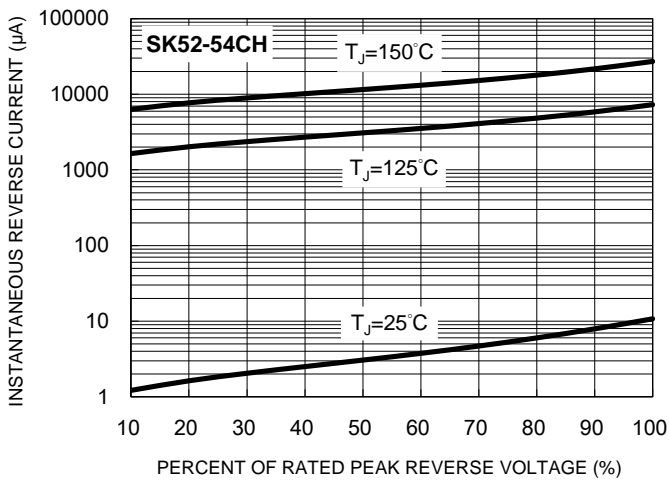


Fig.4 Typical Forward Characteristics

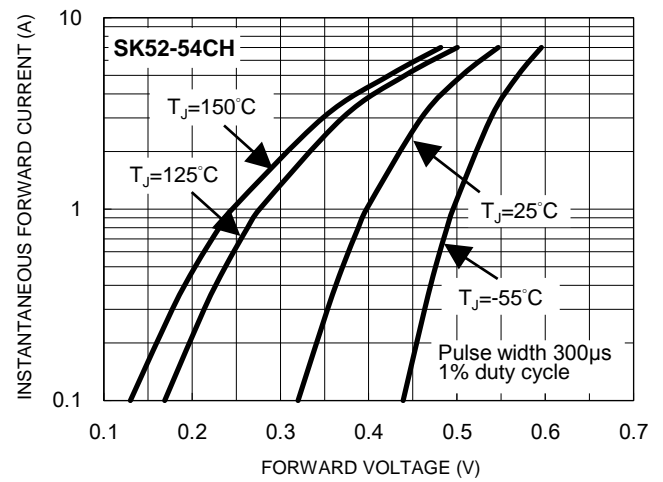


Fig.5 Typical Reverse Characteristics

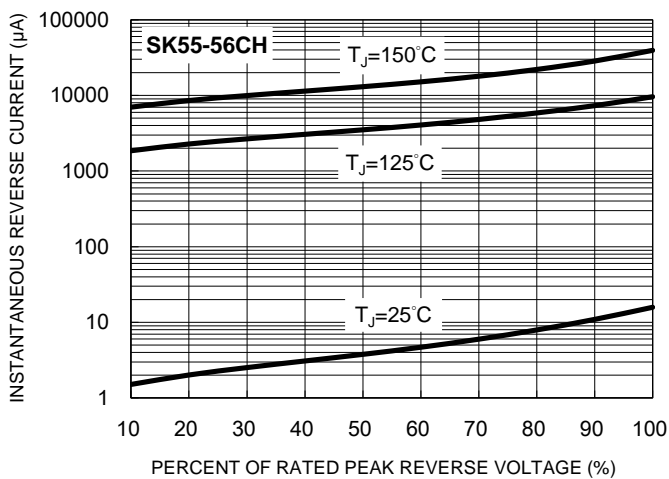
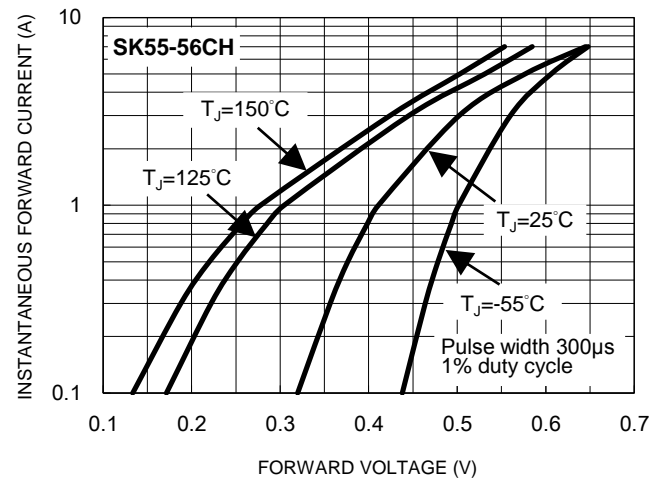


Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.7 Typical Reverse Characteristics

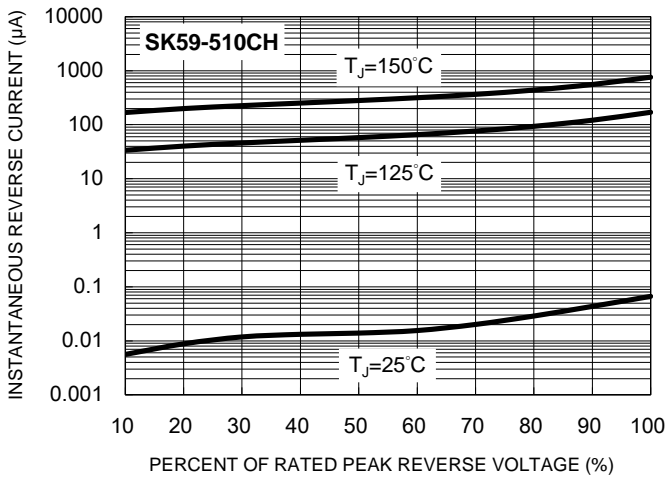


Fig.8 Typical Forward Characteristics

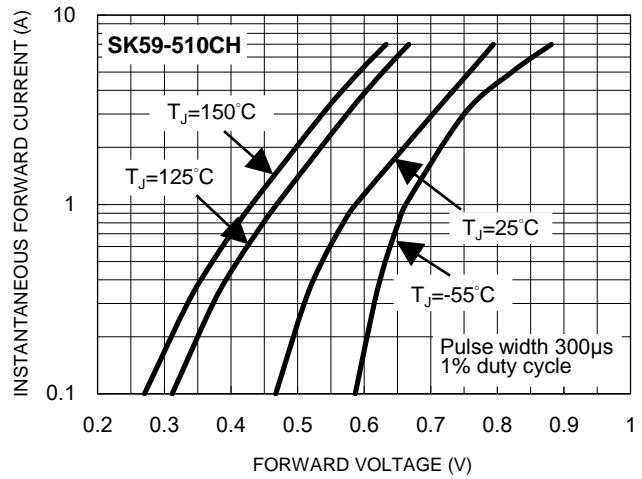


Fig.9 Typical Reverse Characteristics

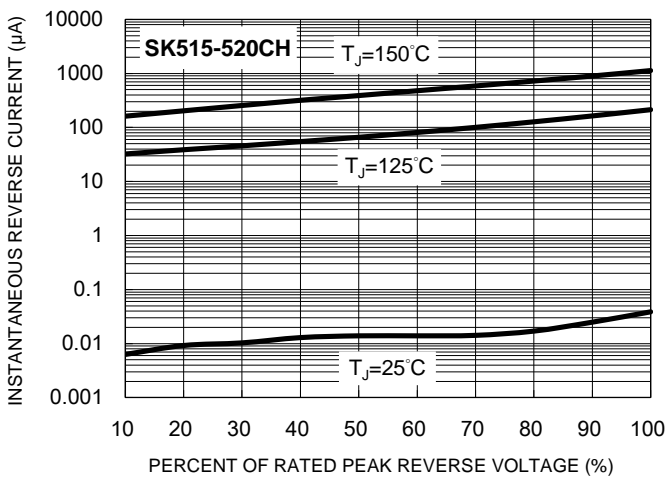


Fig.10 Typical Forward Characteristics

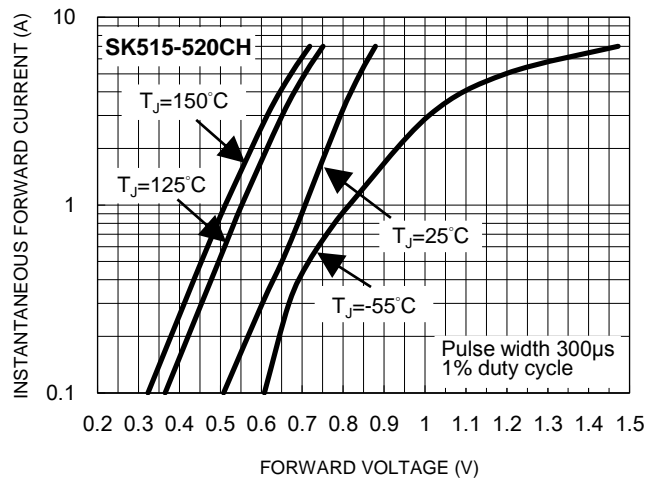
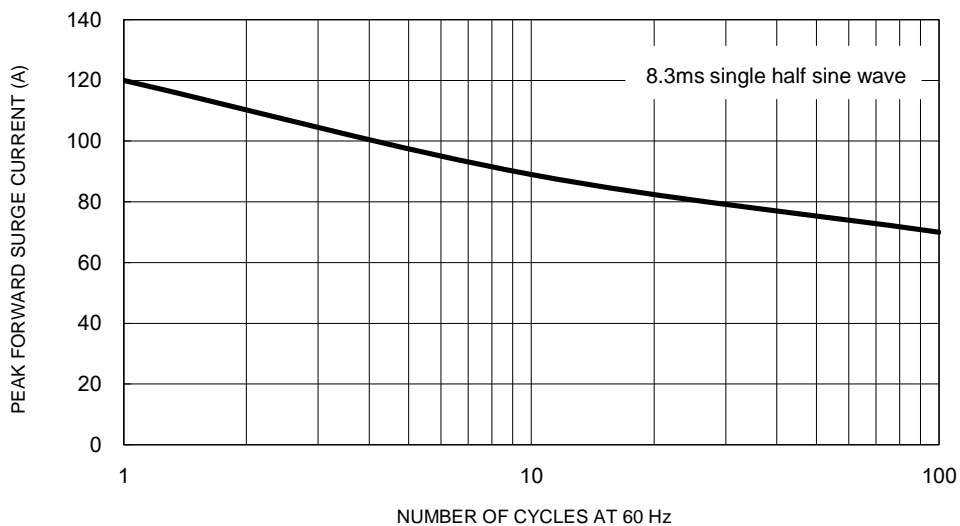


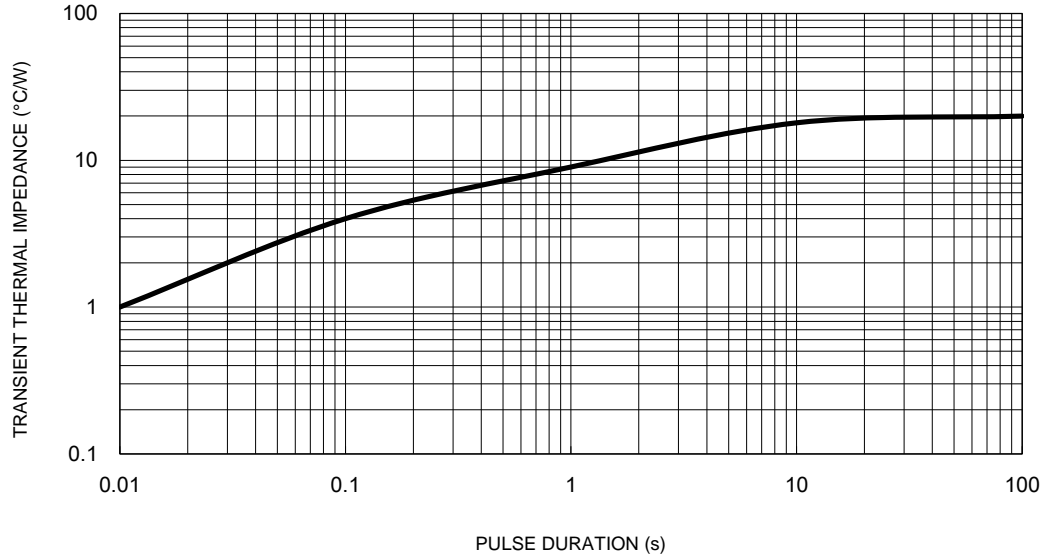
Fig.11 Maximum Non-Repetitive Forward Surge Current



CHARACTERISTICS CURVES

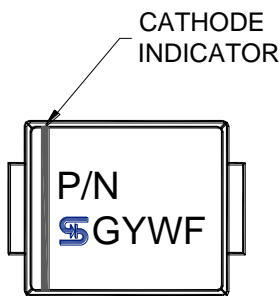
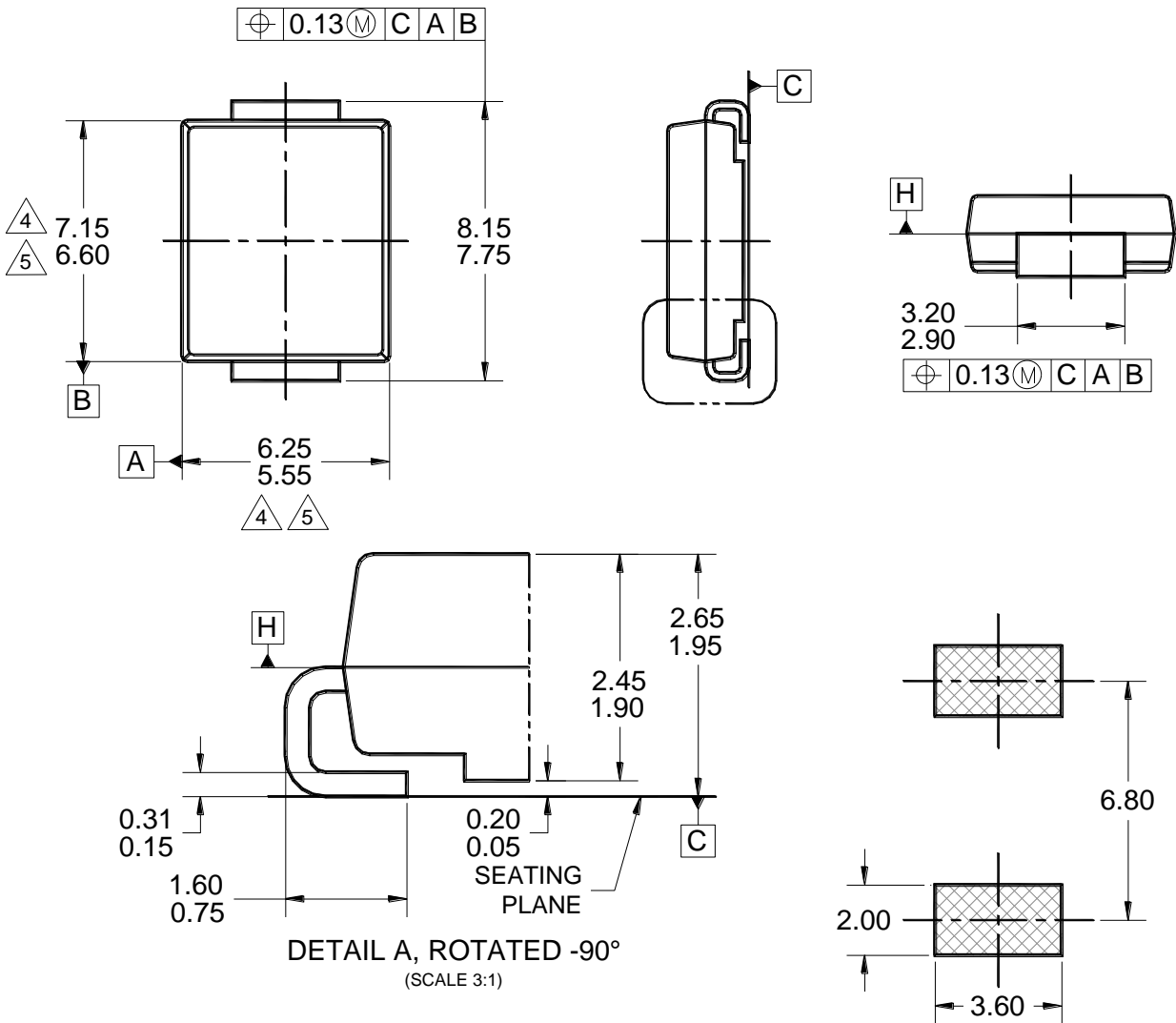
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.12 Typical Transient Thermal Characteristics



PACKAGE OUTLINE DIMENSIONS

DO-214AB (SMC)



MARKING DIAGRAM

P/N = MARKING CODE
 G = GREEN COMPOUND
 YW = DATE CODE
 F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.

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